



# DDTC (R2-ONLY SERIES) KA

**NPN PRE-BIASED SMALL SIGNAL SURFACE MOUNT TRANSISTOR**

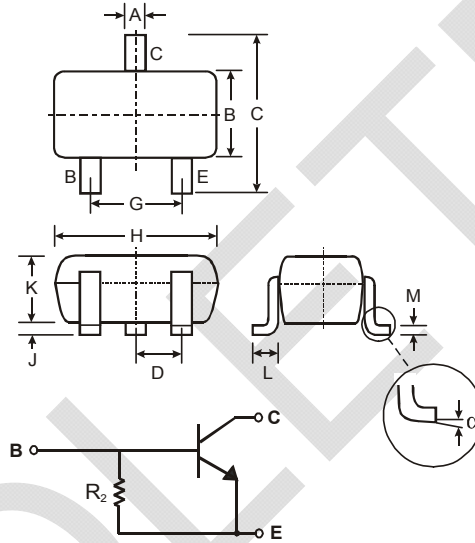
Obsolete Part Number	Alternative Part Number
DDTC114GKA	DDTC114GCA
DDTC115GKA	DDTC115GCA
DDTC124GKA	DDTC124GCA
DDTC144GKA	DDTC144GCA

## Features

- Epitaxial Planar Die Construction
- Complementary PNP Types Available (DDTA)
- Built-In Biasing Resistor, R2 only
- **Lead Free/RoHS Compliant (Note 2)**
- **"Green" Device, Note 3 and 4**

## Mechanical Data

- Case: SC-59
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Copper leadframe).
- Terminal Connections: See Diagram
- Marking Information: See Table Below & Page 3
- Ordering Information: See Page 3
- Weight: 0.006 grams (approximate)



SC-59		
Dim	Min	Max
A	0.35	0.50
B	1.50	1.70
C	2.70	3.00
D	0.95	
G	1.90	
H	2.90	3.10
J	0.013	0.10
K	1.00	1.30
L	0.35	0.55
M	0.10	0.20
α	0°	8°
All Dimensions in mm		

P/N	R2 (NOM)	Type Code
DDTC114GKA	10KΩ	N26
DDTC124GKA	22KΩ	N27
DDTC144GKA	47KΩ	N28
DDTC115GKA	100KΩ	N29

SCHEMATIC DIAGRAM

## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	50	V
Emitter-Base Voltage	V <sub>EBO</sub>	5	V
Collector Current	I <sub>C</sub> (Max)	100	mA
Power Dissipation	P <sub>d</sub>	200	mW
Thermal Resistance, Junction to Ambient Air (Note 1)	R <sub>θJA</sub>	625	°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-55 to +150	°C

- Notes:
1. Mounted on FR4 PC Board with recommended pad layout at <http://www.diodes.com/datasheets/ap02001.pdf>.
  2. No purposefully added lead.
  3. Diodes Inc.'s "Green" policy can be found on our website at [http://www.diodes.com/products/lead\\_free/index.php](http://www.diodes.com/products/lead_free/index.php).
  4. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

**Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage		BV <sub>CBO</sub>	50	—	—	V	I <sub>C</sub> = 50μA
Collector-Emitter Breakdown Voltage		BV <sub>CEO</sub>	50	—	—	V	I <sub>C</sub> = 1mA
Emitter-Base Breakdown Voltage		BV <sub>EBO</sub>	5	—	—	V	I <sub>E</sub> = 720μA, DDTC114GKA I <sub>E</sub> = 330μA, DDTC124GKA I <sub>E</sub> = 160μA, DDTC144GKA I <sub>E</sub> = 72μA, DDTC115GKA
Collector Cutoff Current		I <sub>CBO</sub>	—	—	0.5	μA	V <sub>CB</sub> = 50V
Emitter Cutoff Current	DDTC114GKA	I <sub>EBO</sub>	300	—	580	μA	V <sub>EB</sub> = 4V
	DDTC124GKA		140		260		
	DDTC144GKA		65		130		
	DDTC115GKA		30		58		
Collector-Emitter Saturation Voltage		V <sub>CE(sat)</sub>	—	—	0.3	V	I <sub>C</sub> = 10mA, I <sub>B</sub> = 0.5mA
DC Current Transfer Ratio	DDTC114GKA	h <sub>FE</sub>	30	—	—	—	I <sub>C</sub> = 5mA, V <sub>CE</sub> = 5V
	DDTC124GKA		56				
	DDTC144GKA		68				
	DDTC115GKA		82				
Bleeder Resistor (R <sub>2</sub> ) Tolerance		ΔR <sub>2</sub>	-30	—	+30	%	—
Gain-Bandwidth Product*		f <sub>T</sub>	—	250	—	MHz	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz

\* Transistor - For Reference Only

OBSOLETE

Typical Curves – DDTC114GKA

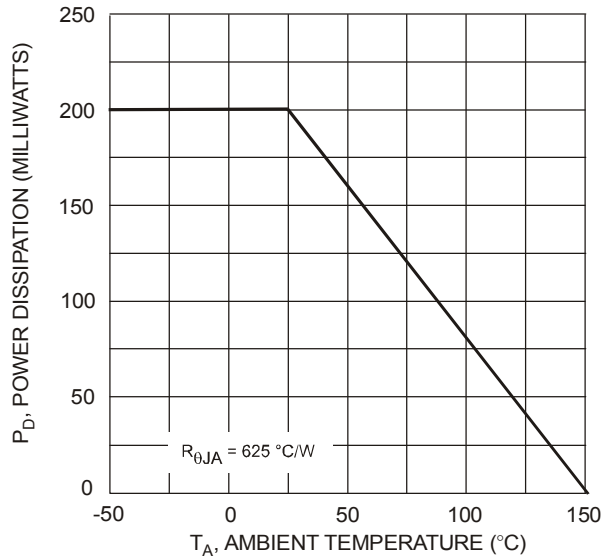


Fig. 1 Derating Curve

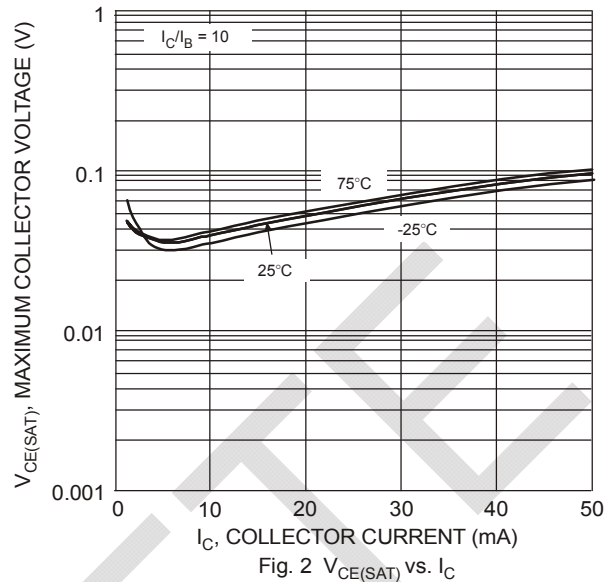


Fig. 2  $V_{CE(SAT)}$  vs.  $I_C$

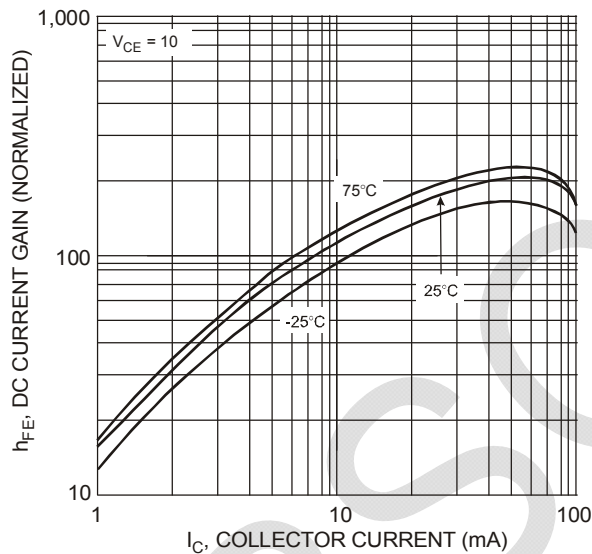


Fig. 3 DC Current Gain

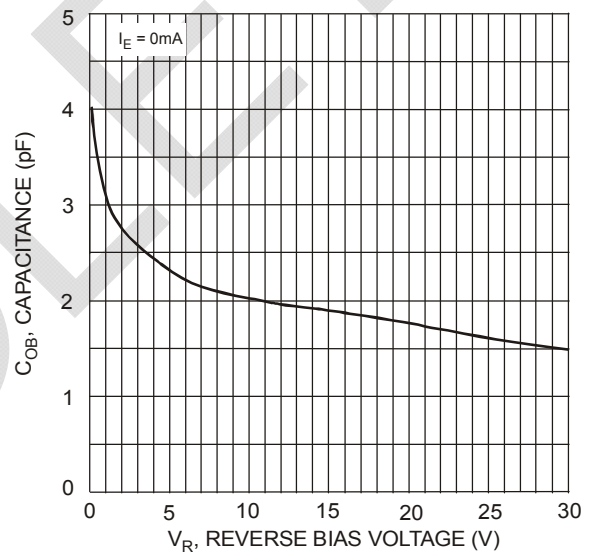


Fig. 4 Output Capacitance

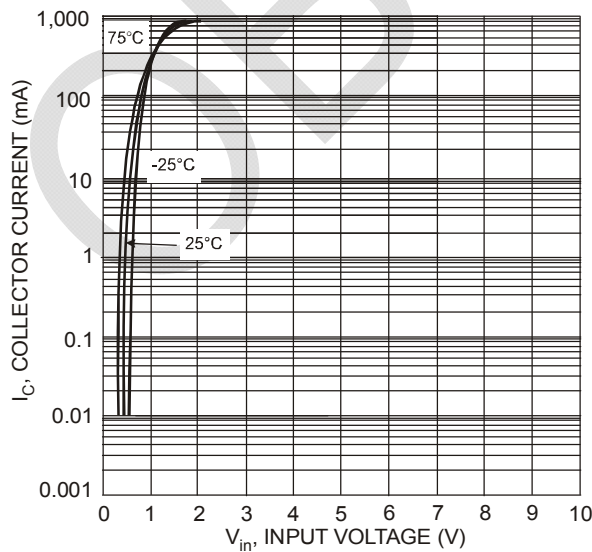


Fig. 5 Collector Current vs. Input Voltage

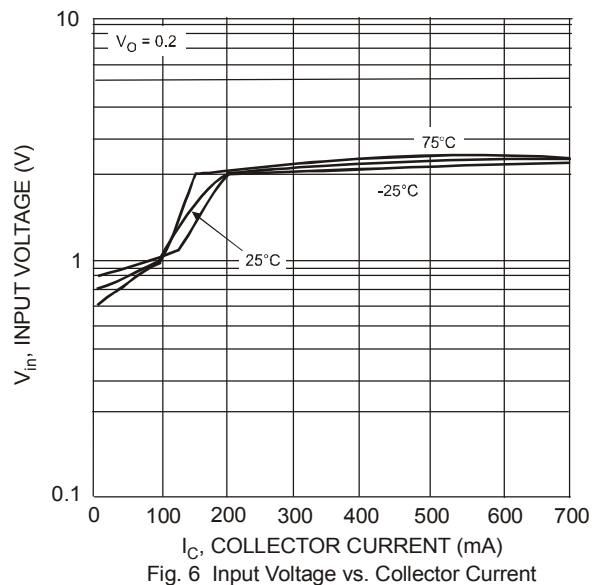


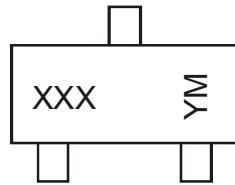
Fig. 6 Input Voltage vs. Collector Current

**Ordering Information** (Note 4 & 5)

Device	Packaging	Shipping
DDTC114GKA-7-F	SC-59	3000/Tape & Reel
DDTC124GKA-7-F	SC-59	3000/Tape & Reel
DDTC144GKA-7-F	SC-59	3000/Tape & Reel
DDTC115GKA-7-F	SC-59	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

**Marking Information**



XXX = Product Type Marking Code, See Table on Page 1  
 YM = Date Code Marking  
 Y = Year ex: T = 2006  
 M = Month ex: 9 = September

Date Code Key

Year	2006	2007	2008	2009	2010	2011	2012
Code	T	U	V	W	X	Y	Z

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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